

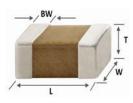


## Specification of Automotive MLCC (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL10C102JB81PNC
- Description : CAP, 1nF, 50V, ± 5%, C0G, 0603
- AEC-Q200 Qualified

## A. Dimension

Dimension



Size	0603 inch
L	1.60±0.10 mm
W	0.80±0.10 mm
Т	0.80±0.10 mm
BW	0.30±0.20 mm

## B. Samsung Part Number

	<u>CL</u> ①	<u>10</u> ②	<mark>С</mark> 3	<u>102</u> ④	<mark>]</mark> 5	<u>B</u> 6	<u>8</u> ⑦	<u>1</u> ®	<u>P</u> 9	<u>N</u> ®	<u>C</u> 10	
① Series	Samsung	Multi-la	ayer Cer	amic Cap	acitor							
② Size	06	603 (i	nch cod	le)		L: 1.	.60±0.10	mm		W: 0	.80±0.10 mm	1
③ Dielectric	C	0G				(8) In	ner elec	trode		Ni		
		4				-				~		

④ Capacitance	1 nF	Termination	Cu
<b>⑤</b> Capacitance	± 5%	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
⑥ Rated Voltage	50 V	Special code	Normal
⑦ Thickness	0.80±0.10 mm	① Packaging	Cardboard Type, 7" Reel

## C. Reliability Test and Judgement condition

	Performance	Test condition			
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature			
Exposure	Capacitance Change : Within ±2.5% or 0.25pF	Measurement at 24±2hrs after test conclusion			
•	whichever is larger				
	Q : 1,000 min.				
	IR : More than 10,000 M $ \Omega $ or 500 M $ \Omega \times \mu F $				
	Whichever is smaller				
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles			
	Capacitance Change : Within ±2.5% or 0.25pF	Measurement at 24±2hrs after test conclusion			
	whichever is larger				
	Q : 1,000 min.	1 cycle condition : $-55+0/-3^{\circ}C(30\pm 3\min) \rightarrow \text{Room Temp.}$ (1min)			
	IR : More than 10,000 <sup>M</sup> Ω or 500 <sup>M</sup> Ω× <i>μ</i> F	→ 125+3/-0 °C (30±3min) → Room Temp. (1min)			
	Whichever is smaller				
Destructive Physical	No Defects or abnormalities	Per EIA 469			
Analysis					
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85°C/85%RH, Rated Voltage and 1.3~1.5V,			
	Capacitance Change : Within ±2.5% or 0.25 pF	Add 100kohm resistor			
	whichever is larger				
	Q : 200 min.	The charge/discharge current is less than 50mA.			
	IR : More than 500 $^{M\Omega}$ or 25 $^{M\Omega} \times \mu^{F}$				
	Whichever is smaller				
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125 °C, 200% Rated Voltage,			
Operating Life	Capacitance Change : Within ±3% or 0.3pF	Measurement at 24±2hrs after test conclusion			
	whichever is larger	The charge/discharge current is less than 50mA.			
	Q: 350 min.				
	IR : More than 1,000 M $\Omega$ or 50 M $\Omega \times \mu$ F				
	Whichever is smaller				

	Performance	Test condition					
External Visual	No abnormal exterior appearance	Microscope ('10)					
Physical Dimensions	Within the specified dimensions	Using The calipers					
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along					
	Capacitance Change : Within ±2.5% or 0.25pF	3 mutually perpendicular axes of the test specimen (18 shocks)					
	whichever is larger	Peak value Duration Wave Velocity					
		1,500G 0.5ms Half sine 4.7m/sec					
	Q, IR : Initial spec.						
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,					
	Capacitance Change : Within ±2.5% or 0.25pF	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted					
	whichever is larger						
		within 2" from any secure point. Test from $10~2,000$ Hz.					
	Q, IR : Initial spec.						
Resistance to	Appearance : No abnormal exterior appearance	preheating : 150°C for 60~120 sec.					
Solder Heat	Capacitance Change : Within ±2.5% or 0.25pF	Solder pot : 260±5℃, 10±1sec.					
	whichever is larger						
	Q, IR : Initial spec.						
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605					
	Capacitance Change : Within ±2.5% or 0.25pF						
	whichever is larger						
Caldenah iliter	Q, IR : Initial spec. 95% of the terminations is to be soldered	a) Preheat at 155 °C for 4 hours, Immerse in solder for 5s at 245±5 °C					
Solderability	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at $245\pm5$ °C					
		c) Steam aging for 8 hours, Immerse in solder for 120s at $26\pm0^{\circ}$					
		solder : a solution ethanol and rosin					
Electrical	Capacitance : Within specified tolerance	The Capacitance / D.F. should be measured at 25 °C,					
Characterization	Q : 1,000 min.	1 <sup>M/z</sup> ± 10%, 0.5~5 Vrms					
	IR(25℃): More than 100,000 <sup>M</sup> or 1,000 <sup>M</sup> ×µ <sup>F</sup>	I.R. should be measured with a DC voltage not exceeding					
	Whichever is smaller	Rated Voltage @25 ℃, @125 ℃ for 60~120 sec.					
	IR(125℃): More than 10,000 <sup>M</sup> or 100 <sup>M</sup> × <i>µ</i> F						
	Whichever is smaller						
	Dielectric Strength	Dielectric Strength : 300% of the rated voltage for 1~5 seconds					
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds					
	Capacitance Change : Within ±5% or 0.5pF						
	whichever is larger						
Terminal	Appearance : No abnormal exterior appearance	10 N, for 60 sec.					
Strength(SMD)	Capacitance Change : Within ±2.5% or 0.25pF						
	whichever is larger						
Beam Load	Destruction value should be exceed 20 N	Beam speed : 0.5±0.05 mm/sec					
Temperature	C0G						
Characteristics	From -55 °C to 125 °C, Capacitance change should	be within 0±30ppm/℃					

D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260 +0/-5  $^\circ C$  , 30sec. ), Meet IPC/JEDEC J-STD-020 D Standard

A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.